

2MBI300NB-060

IGBT Module

600V / 300A 2 in one-package

■ Features

- High speed switching
- Voltage drive
- Low inductance module structure

■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines



■ Maximum ratings and characteristics

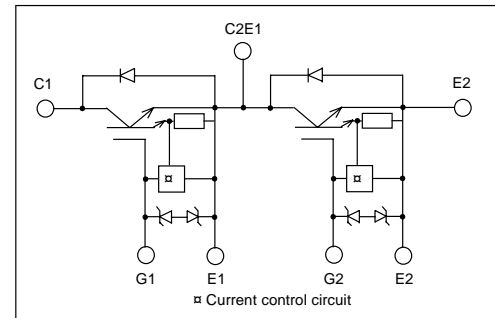
● Absolute maximum ratings (at Tc=25°C unless otherwise specified)

Item	Symbol	Rating	Unit
Collector-Emitter voltage	V _{CES}	600	V
Gate-Emitter voltage	V _{GES}	±20	V
Collector current	Continuous	I _C	300 A
	1ms	I _C pulse	600 A
	Continuous	-I _C	300 A
	1ms	-I _C pulse	600 A
Max. power dissipation	P _c	1100	W
Operating temperature	T _j	+150	°C
Storage temperature	T _{stg}	-40 to +125	°C
Isolation voltage	V _{is}	AC 2500 (1min.)	V
Screw torque	Mounting *1	3.5	N·m
	Terminals *2	4.5	N·m

*1 : Recommendable value : 2.5 to 3.5 N·m(M5) or (M6)

*2 : Recommendable value : 3.5 to 4.5 N·m(M6)

■ Equivalent Circuit Schematic



● Electrical characteristics (at T_j=25°C unless otherwise specified)

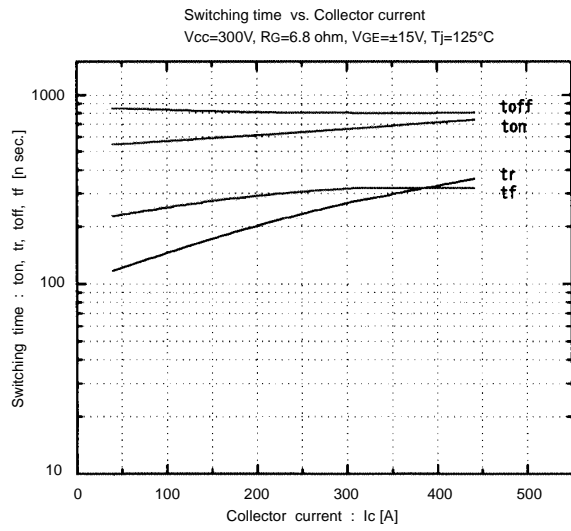
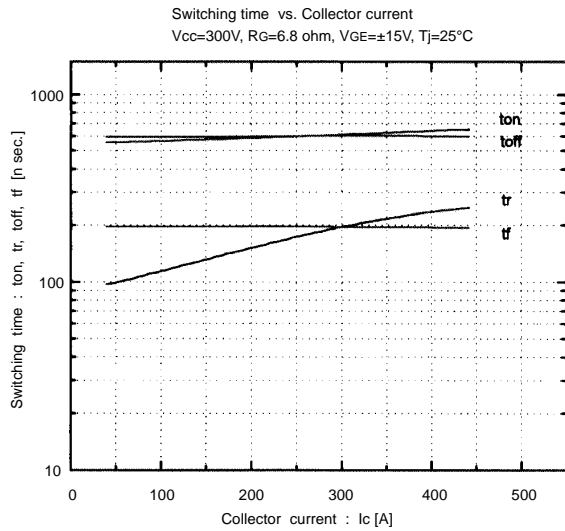
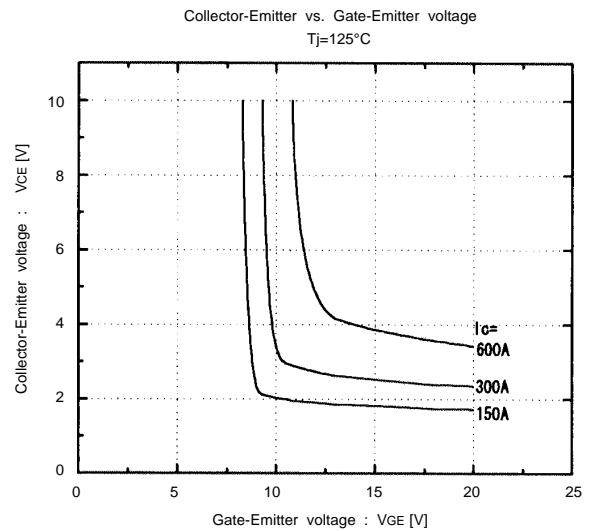
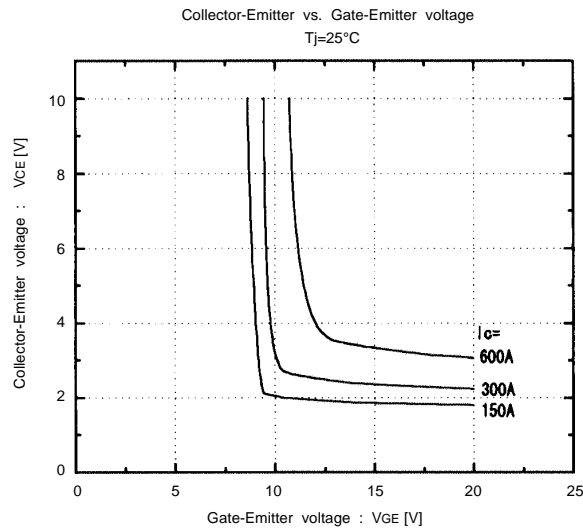
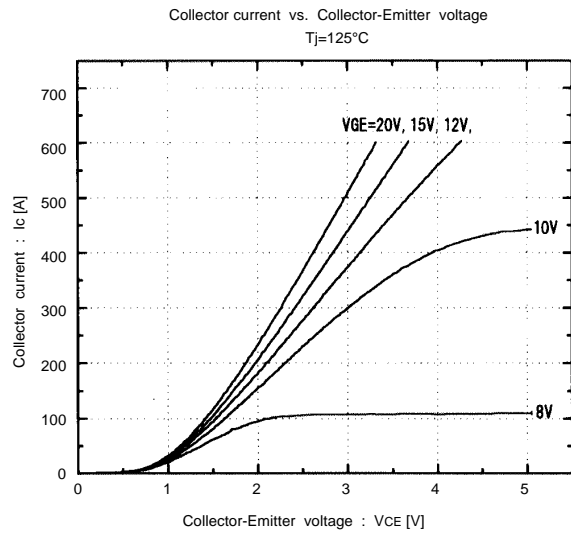
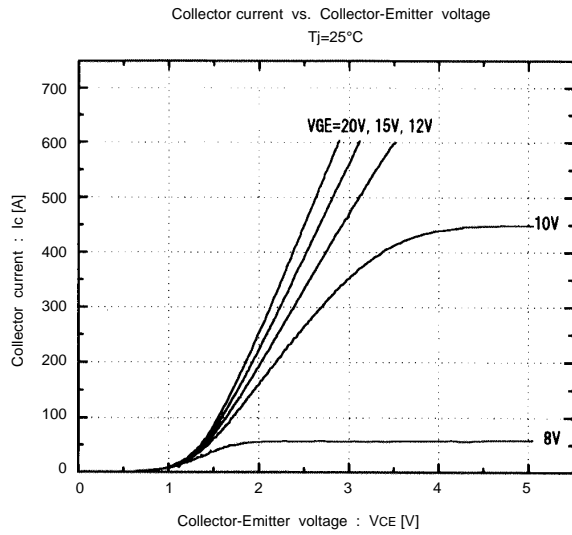
Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	I _{CES}	-	-	2.0	V _{GE} =0V, V _{CE} =600V	mA
Gate-Emitter leakage current	I _{GES}	-	-	30	V _{CE} =0V, V _{GE} =±20V	μA
Gate-Emitter threshold voltage	V _{GE(th)}	4.5	-	7.5	V _{CE} =20V, I _C =300mA	V
Collector-Emitter saturation voltage	V _{CE(sat)}	-	-	2.8	V _{GE} =15V, I _C =300A	V
Input capacitance	C _{ies}	-	19800	-	V _{GE} =0V	pF
Output capacitance	C _{oes}	-	4400	-	V _{CE} =10V	
Reverse transfer capacitance	C _{res}	-	2000	-	f=1MHz	
Turn-on time	t _{on}	-	0.6	1.2	V _{CC} =300V	μs
	t _r	-	0.2	0.6	I _C =300A	
Turn-off time	t _{off}	-	0.6	1.0	V _{GE} =±15V	
	t _f	-	0.2	0.35	R _G =6.8 ohm	
Diode forward on voltage	V _F	-	-	3.0	I _F =300A, V _{GE} =0V	V
Reverse recovery time	t _{rr}	-	-	0.3	I _F =300A	μs

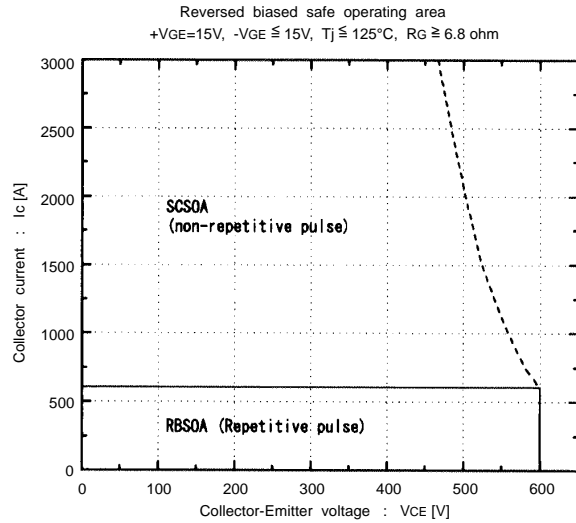
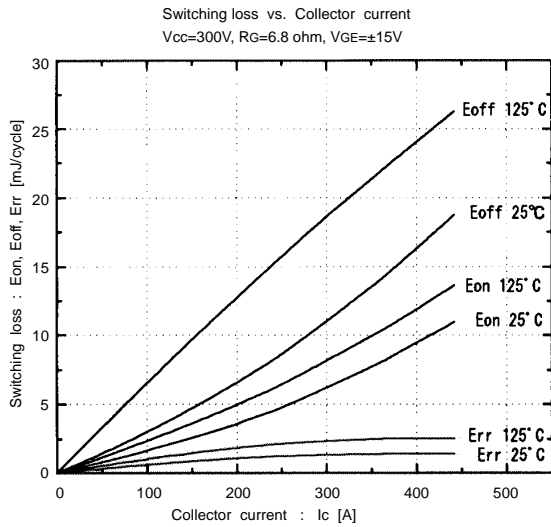
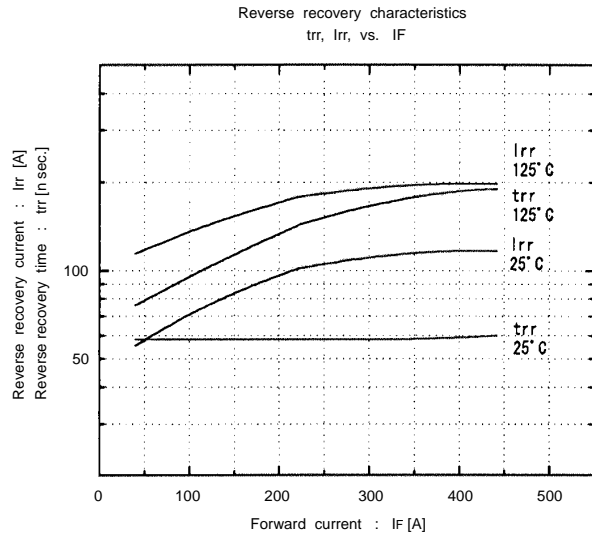
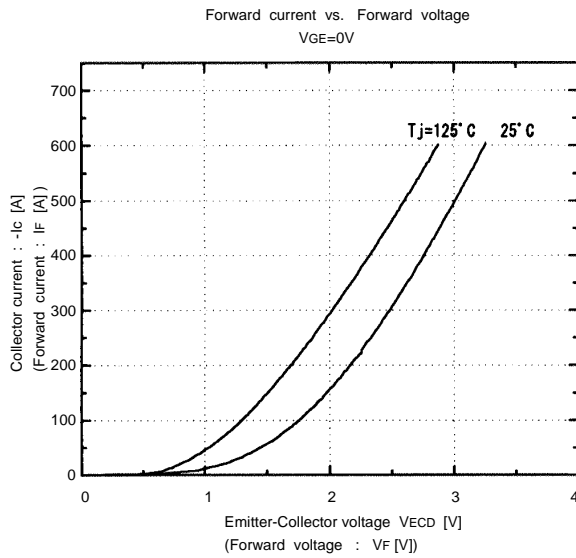
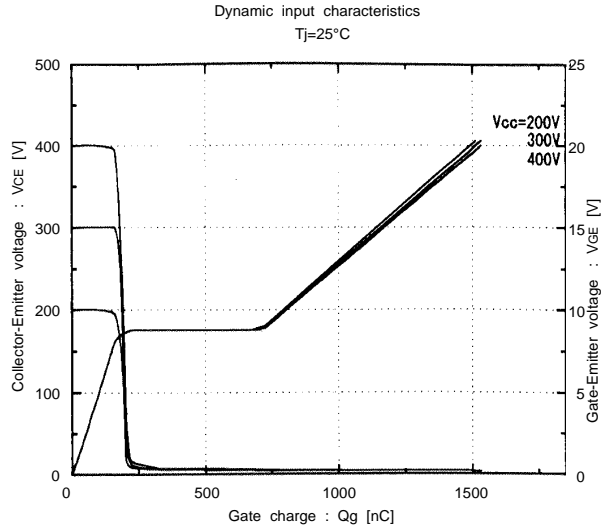
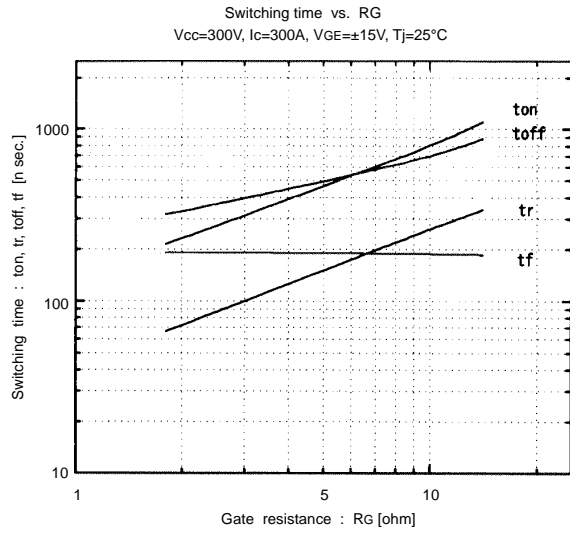
● Thermal resistance characteristics

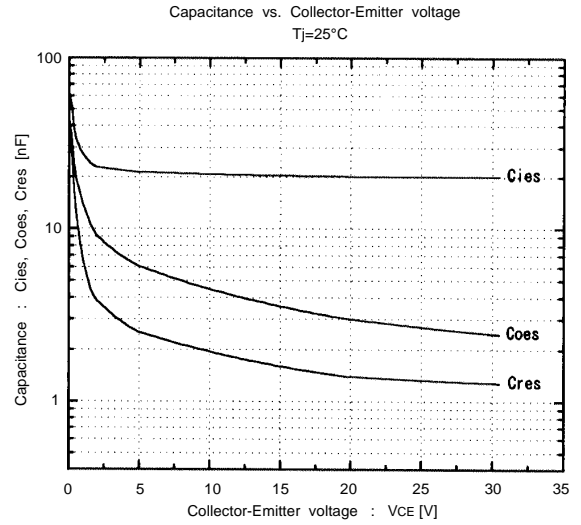
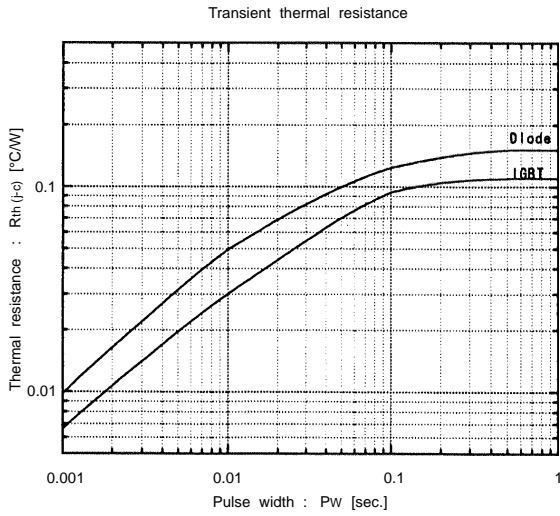
Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	R _{th(j-c)}	-	-	0.11	IGBT	°C/W
	R _{th(j-c)}	-	-	0.15	Diode	°C/W
	R _{th(c-f)*3}	-	0.025	-	the base to cooling fin	°C/W

*3 : This is the value which is defined mounting on the additional cooling fin with thermal compound

■ Characteristics (Representative)







■ Outline Drawings, mm

